

FOR ADDITIONAL INFORMATION CONTACT

Phone: (518) 452-2880

E-Mail: info@yincae.com



YINCAE Advanced Materials, LLC

19 Walker Way, Albany, NY, 12205

FOR IMMEDIATE RELEASE

Press Release

SMT 88UH Fast Cure, Reworkable Underfill

(Albany, NY) 06/07/2014 — YINCAE Advanced Materials, LLC is pleased to announce the availability of the SMT 88UH. SMT 88UH is a new and groundbreaking underfill. It can be underfilled at room temperature without preheating a substrate.

Advantages of the SMT 88UH include:

- ❖ Void-free underfill
- ❖ Easy rework
- ❖ Easy dispensing
- ❖ Outstanding reliability
- ❖ Excellent mechanical resistance

Another great benefit is the fact that it can be stored in a regular refrigerator or freezer. You do not need a specialized freezer to store the SMT 88UH because of its friendly storage conditions.

SMT 88UH is a very versatile underfill. It can be used for more than just underfilling. It can be used for chip scale packaging, ball grid array devices, package on package, land grid array, and certain flip chip applications. It is also suitable for bare chip protection in a variety of advanced packages such as memory cards, chip carriers, hybrid circuits and multi-chip modules.

For more information on YINCAE's SMT 88UH, or to learn more about what YINCAE offers, please email us at: info@yincae.com. You can also find more information by visiting our website at: www.yincae.com

* * * * *

Founded in 2005 & headquartered in Albany, New York, YINCAE Advanced Materials is a leading manufacturer and supplier of thermal interface materials, underfill solutions, die attach adhesives, electronic materials, & high-performance coatings used in microchip & optoelectronic devices. YINCAE products provide new technologies to support manufacturing processes from wafer level, to package level, to board level and final devices while facilitating smarter and faster production and supporting green initiatives.

###

The YINCAE brand name and logo are trademarks of YINCAE Advanced Materials, LLC.